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# 5 MHz 14-bit 1-channel 300 kSPS cascade delta-sigma ADC

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## SPECIFICATION

### 1 FEATURES

- TSMC CMOS 65 nm
- Cascade (2-2) delta-sigma ADC
- 1.2 V supply voltage
- Input differential signal range – 0.64 V
- Build-in reference voltage source ( $0.6\text{ V} \pm 0.2\text{ V}$ )
- Portable to other technologies (upon request)

### 2 APPLICATION

- Analog to digital conversion of the signal
- Receivers, transmitters, transceivers
- Measurement environment
- Medicine environment

### 3 OVERVIEW

The block is fourth order cascade (2-2) delta-sigma ADC with 5-level quantizers in both stages. The block consists of:

- two delta-sigma modulators second order, coupled in series
- clock generator
- bias current source
- CLA-, DWA-, BiDWA-correction of capacitors mismatch
- digital filter

ADC is designed for TSMC CMOS 65 nm technology using 6 levels of metal wiring.

## 4 STRUCTURE

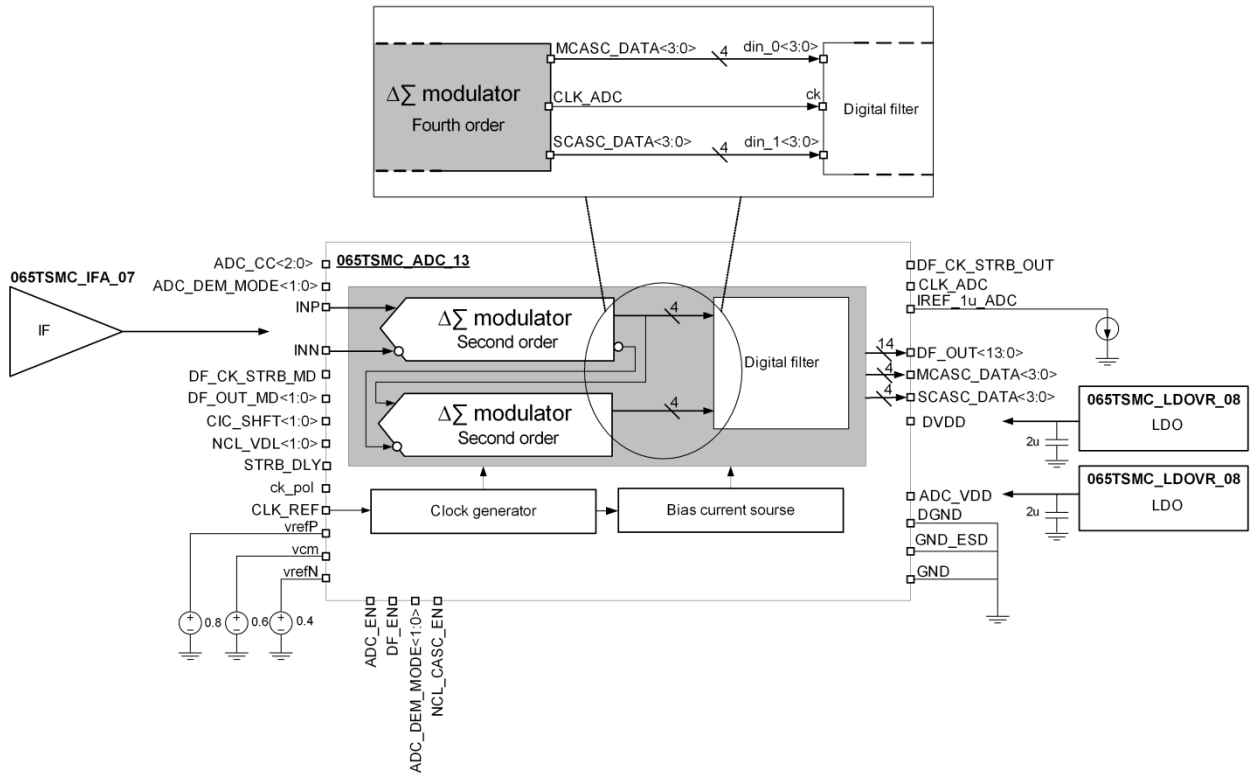


Figure 1: ADC application diagram

## 5 PIN DESCRIPTION

Name	Direction	Description
<i>Delta-sigma modulator</i>		
IREF_1u_ADC	I	ADC reference current (effluent) 1 uA
ADC_EN	I	ADC enable: “0” disabled “1” enabled ( <b>default</b> )
INP	I	Input differential signal
INN		
ADC_CC<2:0>	I	ADC bias current source mode: “000” 0.5 uA “001” 1.0 uA ( <b>default</b> ) ... with step of 0.5 uA “111” 4.0 uA
CLK_REF	I	Reference clock signal 5 MHz
ADC_DEM_MODE<1:0>	I	Correction of capacitors mismatch mode: “00” without correction “01” CLA “10” DWA “11” BiDWA ( <b>default</b> )
CLK_ADC	O	ADC clock output
vrefP	P	Differential reference voltages
vrefN		
vcm	P	Common mode reference voltage
MCASC_DATA<3:0>	O	ADC main cascade digital output data (cascade 0)
SCASC_DATA<3:0>	O	ADC second cascade Digital output data of (cascade 1)
ADC_VDD	P	Analog blocks supply voltage 1.2 V
GND	P	Analog blocks ground
GND_ESD	P	Ground for electrostatic discharge protection
<i>Digital filter</i>		
nrst	I	Digital filter reset: “0” reset “1” active mode ( <b>default</b> )
ck_pol	I	Digital filter clock signal polarity: “0” direct ( <b>default</b> ) “1” inverse
ck	I	Digital filter clock input
DF_EN	I	Digital filter enable: “0” disabled “1” enabled ( <b>default</b> )
din_0<3:0>	I	Digital filter input data from ADC main cascade (cascade 0)
din_1<3:0>	I	Digital filter input data from ADC second cascade (cascade 1)

Table "Pin description". Continue

Name	Direction	Description
NCL_CASC_EN	I	Quantization noise compensation enable: "0" disabled "1" enabled (default)
DF_OUT_MD<1:0>	I	Output signal mode: "00" noise cancellation circuit output
		"01" first cascade of digital filter output data, decimation coefficient is 4
		"10" second cascade of digital filter output data, decimation coefficient is 8
		"11" third cascade of digital filter output data (main output), decimation coefficient is 16 (default)
DF_CK_STRB_MD	I	Output data synchronization mode: "0" synchronization by rising edge of CLK_REF (default) "1" synchronization by rising edge of CLK_ADC
NCL_VDL<1:0>	I	The clock delay value of main stage with respect to the second stage in noise cancellation circuit: "00" 0 "01" 1 "10" 2 (default) "11" 3
STRB_DLY	I	Synchronization correction register in digital filtering block
CIC_SHFT<1:0>	I	CIC filter gain: "00" ×1 "01" ×2 "10" ×4 "11" ×8 (default)
DF_CK_STRB_OUT	I	Synchronization signal of output data
DF_OUT<13:0>	O	Digital filter output
DVDD	P	Digital filter supply voltage 1.2V
DGND	P	Digital filter ground

## 6 FUNCTIONAL DESCRIPTION

ADC can operate in two modes: standby mode and active mode, which could be selected by logic levels at ADC\_EN and DF\_EN inputs:

- ADC\_EN = “0”, DF\_EN = “0”: Standby mode. Analog blocks and digital filter are disabled; external LDO and voltage reference source are enabled. Low power consumption
- ADC\_EN = “1”, DF\_EN = “1”: Active mode. Analog blocks and filter are enabled. High power consumption

After power on supply, ADC\_EN and DF\_EN inputs should be enabled by high level voltage (logic “1”) and at least 6 ms should pass for voltage reference stabilization.

After disable of standby mode, at least 50 us should pass to stabilize signal at the output of ADC. Delta-sigma modulator includes capacitor mismatch correction circuit. This block implements CLA (Clocked Averaging), DWA (Data Weighted Averaging), BiDWA (Bi-directional Data Weighted Averaging) algorithms. ADC operation without using correction algorithm is also possible.

Due to process variations, synchronization errors of the internal system clock of the digital filter could appear. To overcome this it is recommended to add an additional time shift in the internal clock by high voltage level (logic “1”) at input STRB\_DLY. Timing diagram of ADC module is shown in Figure 2.

The digital filter is clocked by delta-sigma modulator (CLK\_ADC output). Synchronization of output data could be carried out in two ways, depending on the logic level in DF\_CK\_STRB\_MD input:

- DF\_CK\_STRB\_MD = “0”: synchronization by rising edge of DF\_CK\_STRB\_OUT
- DF\_CK\_STRB\_MD = “1”: synchronization by rising edge of CLK\_ADC

Output signal is presented in 14-bit binary code at output of the digital filter. The direct data of delta-sigma modulator is also available in 8 bit (4 bit per cascade) thermometer code.

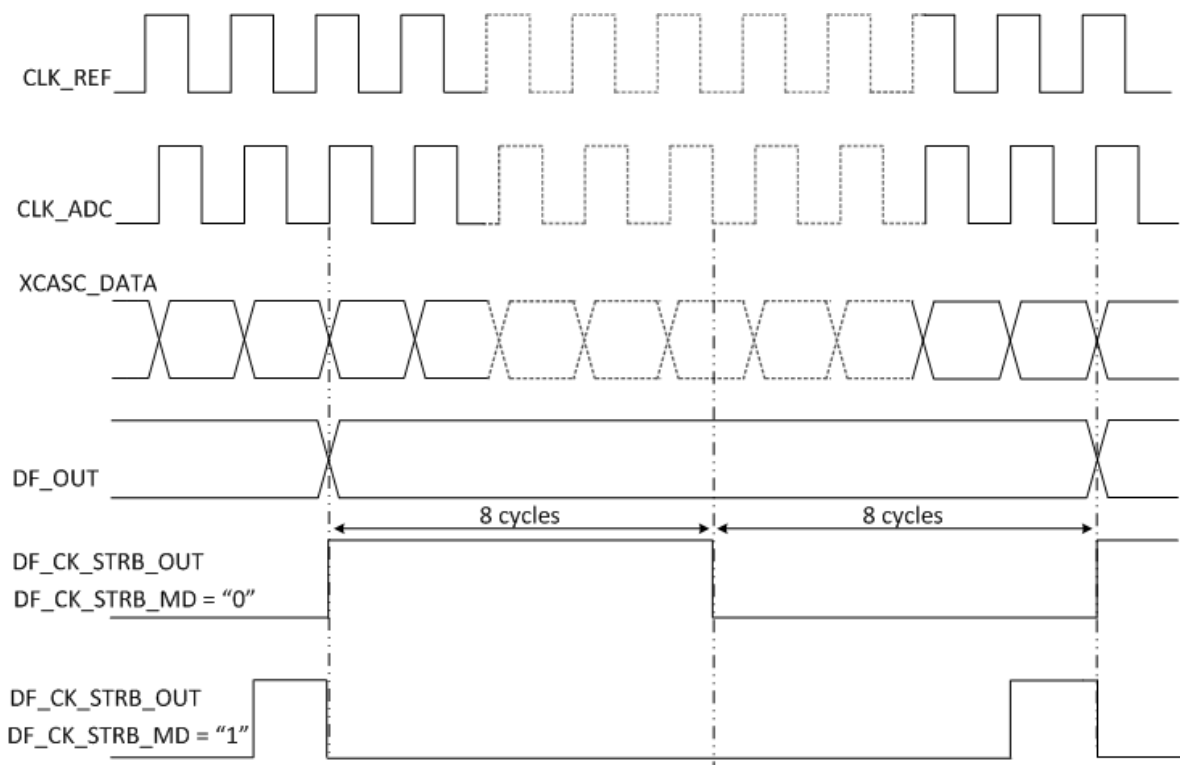


Figure 2: Timing diagram

## 7 LAYOUT DESCRIPTION

Table 1: Delta-sigma modulator dimensions

Dimension	Value	Unit
Height	831	um
Width	230	um

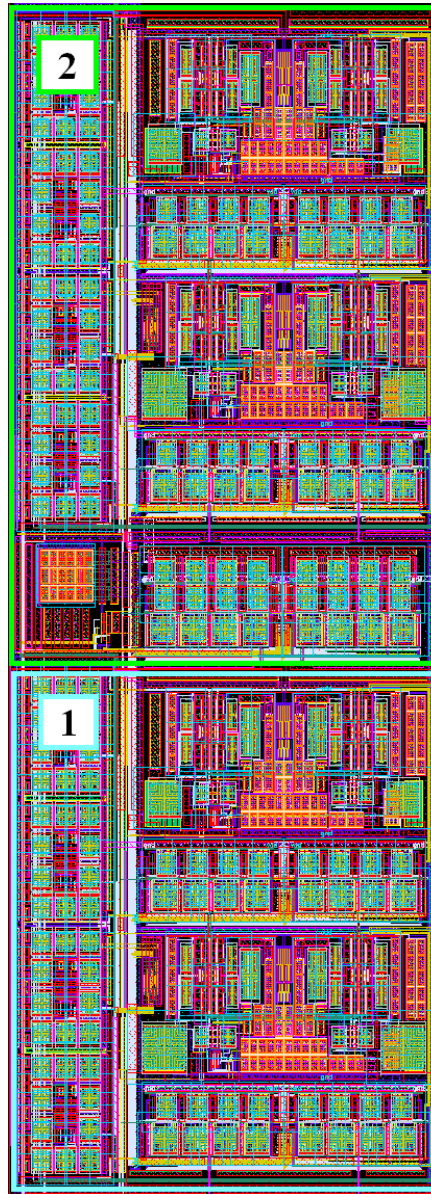


Figure 3: Delta-sigma modulator layout view

1. Main cascade of delta-sigma modulator (cascade 0)
2. Second cascade of delta-sigma modulator (cascade 1)

## 8 INTEGRATION GUIDELINES

Input differential signal connects to INP and INN inputs. Signal sources should be located as close as possible to ADC inputs to minimize parasitic influence of neighbor blocks and wiring.  $v_{refP}$ ,  $v_{refN}$ ,  $v_{cm}$  inputs should be connecting with external capacitors of nominal value of 2  $\mu\text{F}$  for stabilizing voltage reference.

Clock signal should be connected to input CLK\_REF. It must have rising/falling edge no more than 1ns. Transitions are measured at levels  $0.1 \cdot V_{DD}$  and  $0.9 \cdot V_{DD}$ .

Control inputs (ADC\_EN, ADC\_DEM\_MODE  $\langle 1:0 \rangle$ , ADC\_CC  $\langle 2:0 \rangle$ ) should have rising/falling edge no more than 5ns. They are used to select operating mode and are the same when ADC is used.

### 8.1 PLACEMENT AND ROUTING

The following requirements of placement and routing must be satisfied during integration:

- No routing and placement of any topological elements are allowed over the block
- Power supply (pin ADC\_VDD) and ground (pin GND) wires for analog blocks must allow flowing of 2mA current (6mA peak current) and should have total resistance of less than 2 Ohm each
- Power supply (pin DVDD) and ground (pin DGND) wires for digital blocks must allow flowing of 0.8 mA current (3 mA peak current) and should have total resistance of less than 5 Ohm each
- The minimum distance between analog part of ADC (sigma-delta modulator) and neighboring blocks must be 10-15  $\mu\text{m}$ . It is recommended to fill the space between GND and ADC\_VDD by the filter capacitors
- Do not place high-frequency and noisy circuits close to analog part of ADC
- It is recommended to surround the block of delta-sigma modulator by deep n-well guard ring
- It is recommended to surround the digital block by deep n-well guard ring
- The length of output wires of delta-sigma modulator (MCASC\_DATA  $\langle 3:0 \rangle$ , SCASC\_DATA  $\langle 3:0 \rangle$ ) must be of less than 250  $\mu\text{m}$ . Their resistance should be of less than 100 ohms for each and their total capacity (including parasitic) should be of less than 1.5 pF each

## 9 OPERATING CHARACTERISTICS

### 9.1 TECHNICAL CHARACTERISTICS

Technology	TSMC CMOS 65 nm
Status	silicon proven
Delta-sigma modulator area	0.19 mm <sup>2</sup>
Digital filter area	0.042 mm <sup>2</sup>
Total area	0.232 mm <sup>2</sup>

### 9.2 ELECTRICAL CHARACTERISTICS

The values of electrical parameters are given for ADC\_VDD = 1.14 ÷ 1.26 V, DVDD = 1.08 ÷ 1.32 V and Tj = -40 ÷ +85°C, unless otherwise specified; typical values are given for ADC\_VDD = 1.2 V, DVDD = 1.2 V and Tj = 27° C.

Parameter	Symbol	Condition	Value			Unit
			min	typ.	max	
Operating temperature	Tj	-	-40	27	+85	°C
Delta-sigma modulator supply voltage (ADC_VDD)	V <sub>DSM</sub>	-	1.14	1.2	1.26	V
Digital filter supply voltage	DVDD	-	1.14	1.2	1.26	V
Delta-sigma modulator current consumption	I <sub>DSM</sub>	-	90.1	101.7	127	uA
Digital filter current consumption	I <sub>DVDD</sub>	-	75	100	125	uA
Clock frequency	F <sub>clk</sub>	-	-	5	-	MHz
Oversampling ratio	OSR	-	-	16	-	-
Bandwidth	BW	-	-	150	-	kHz
Signal to noise ratio	SNR	BW = 150 kHz	60	67	72	dB
Spurious free dynamic range	SFDR	-	-	78	-	dB
Clock input duty cycle	S	-	45	50	55	%
Clock signal period jitter	T <sub>JIT</sub>	-	-	50	-	pS
Common mode voltage	v <sub>cm</sub>	-	-	0.6	-	V
Differential reference voltage	v <sub>refP</sub>	-	-	0.8	-	V
	v <sub>refN</sub>	-	-	0.4	-	
Input logic high level	V <sub>IH</sub>	For digital inputs	0.8·V <sub>DSM</sub>	-	V <sub>DSM</sub> +0.1	V
Input logic low level	V <sub>IL</sub>		-0.1	-	0.2V <sub>DSM</sub>	V
Output logic high level	V <sub>OH</sub>	-	-	DVDD	-	V
Output logic low level	V <sub>OL</sub>	-	-	0	-	V



### 9.3 DYNAMICAL CHARACTERISTICS

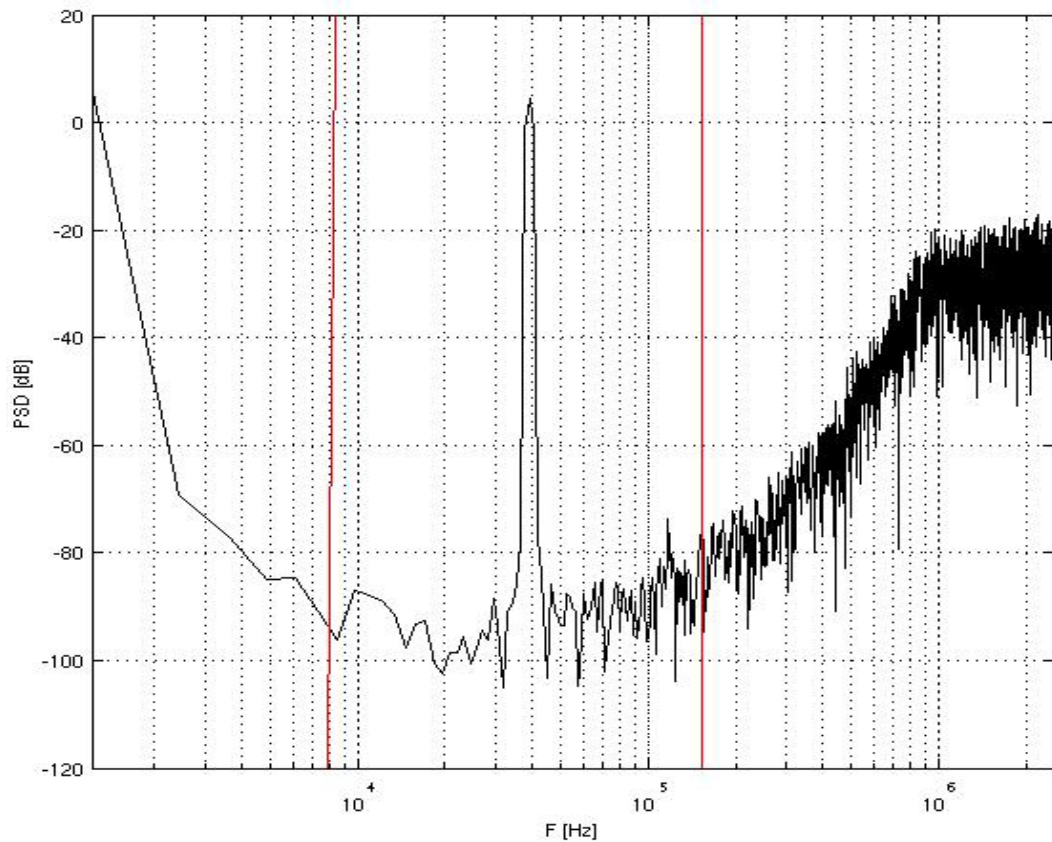


Figure 4: Delta-sigma modulator output signal spectrum

### 10 DELIVERABLES

IP contents include:

- Schematic or NetList
- Abstract model (.dua and .lib files)
- Layout (optional)
- Behavioral device model (Verilog)
- Extracted view (optional)
- HDL-description of digital filters
- GDSII
- DRC, LVS, antenna report
- Test bench with saved configurations (optional)
- Documentation

### 11 REVISION HISTORY

From version 1.0:

- Subsection 9.1 updated:
  - Digital filter area value was changed from 0.38 to 0.042 mm<sup>2</sup>
- Subsection 9.2 updated:
  - Digital filter current consumption value was changed